



InAsSb photovoltaic detectors

With band-pass filter

P16112/P16612/P16849 series

NEW

Back-illuminated type infrared detectors with band-pass filter (3.3 μm, 3.9 μm, 4.26 μm, 4.45 μm)

These are InAsSb photovoltaic detectors that use a band-pass filter for the window material. By using a back-illuminated structure, we greatly improved the sensitivity temperature coefficient compared to the front-illuminated type. Types using a band-pass filter with a center wavelength of 3.3 μ m, 3.9 μ m, or 4.26 μ m are suitable for gas measurement, and a type using a band-pass filter of 4.45 μ m is suitable for flame monitoring. These are environmentally friendly infrared detectors and do not use lead, mercury, or cadmium, which are substances restricted by the RoHS directive. A two-element type that can detect two wavelength is also available.

Features

- High sensitivity
- High-speed response
- High shunt resistance
- Compact, surface mount ceramic package
- Compatible with lead-free solder reflow (ceramic package)

- Applications

- Gas measurement (CH4, CO2)
- Flame monitors (CO2 resonance radiation)
- Option (sold separately)
- Amplifier for infrared detector

C4159-01

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Structure

Type no.	Number of elements	Photosensitive area (mm)	Window material ^{*1}	Package	Cooling	Field of view FOV (degrees)
P16112-033MF			BPF (3.3 µm)			
P16112-039MF			BPF (3.9 µm)	TO-46		87
P16112-043MF			BPF (4.26 µm)	10-40		67
P16112-045MF	4		BPF (4.45 µm)			
P16612-033CF	L		BPF (3.3 µm)			
P16612-039CF		07.07	BPF (3.9 µm)			
P16612-043CF		0.7 × 0.7	BPF (4.26 µm)		Non-cooled	
P16612-045CF			BPF (4.45 µm)	Ceramic		86
P16849-011CF			BPF (3.3 µm)	Ceramic		80
P10049-011CF	2	BPF (3.9 µm)				
P16849-012CF	2				BPF (4.26 µm)	
F10049-012CF			BPF (3.9 µm)			

*1: BPF: Band-pass filter. For windowless and AR coating types, refer to the P16612-011CN datasheet.

Absolute maximum ratings (Typ. Ta=25 °C, unless otherwise noted)

Type no.	Reverse voltage VR (V)	Operating temperature*2 Topr (°C)	Storage temperature*2 Tstg (°C)	Incident light level (W/mm²)	Soldering temperature Tsol (°C)
P16112-033MF					
P16112-039MF					
P16112-043MF					-
P16112-045MF					
P16612-033CF	1	-40 to +85	-40 to +85	1	
P16612-039CF	I	-10 10 +05	-10 10 +05	T	
P16612-043CF					240 (once)*3
P16612-045CF					
P16849-011CF					
P16849-012CF					

*2: No dew condensation

When there is a temperature difference between a product and the surrounding area in high humidity environments, dew condensation may occur on the product surface. Dew condensation may cause deterioration in characteristics and reliability.

*3: Reflow soldering, JEDEC J-STD-020 MSL 2, see P.8

Note: Exceeding the absolute maximum ratings even momentarily may cause a drop in product quality. Always be sure to use the product within the absolute maximum ratings.

Electrical and optical characteristics (Typ. Ta=25 °C, unless otherwise noted)

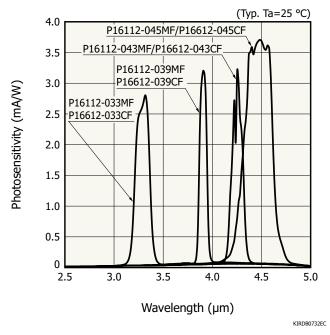
Type no.		Cente velen CWL	gth	resp half v FW	width HM	Photosensitivity S λ=CWL	Shunt resistance Rsh VR=10 mV	C (CWL, 1	ctivity)* 1200, 1)	po N	quivalent wer EP λρ	Rise time tr*4	Terminal capacitance Ct* ⁵
	Min. (nm)		Max. (nm)			(mA/W)	-	∣ inn.	Typ. (cm·Hz ^{1/2} /W)	Typ. (W/Hz ^{1/2})	Max. (W/Hz ^{1/2})	(ns)	(pF)
P16112-033MF			3330		180	2.8		3.2 × 10 ⁸	6.5×10^{8}	1.1 × 10 ⁻¹⁰	2.2 × 10 ⁻¹⁰		
P16112-039MF	3820	3900	3980	90	110	3.2		3.7×10^{8}	7.4×10^{8}	9.5 × 10 ⁻¹¹	1.9×10^{-10}		
P16112-043MF	4217	4260	4303	140	160	3.2]	3.7 × 10 ⁸	7.4×10^{8}	9.5 × 10 ⁻¹¹	1.9×10^{-10}		
P16112-045MF	4400	4450	4500	350	400	3.7]				1.6×10^{-10}		
P16612-033CF	3270	3300	3330	160	180	2.8		3.2×10^{8}	6.5×10^{8}	1.1×10^{-10}	2.2×10^{-10}		
P16612-039CF	3820	3900	3980	90	110	3.2	100	3.7×10^{8}	7.4×10^{8}	9.5 × 10 ⁻¹¹	1.9×10^{-10}	15	0.5
P16612-043CF	4217	4260	4303	140	160	3.2	180	3.7×10^{8}	7.4×10^{8}	9.5 × 10 ⁻¹¹	1.9×10^{-10}	15	0.5
P16612-045CF	4400	4450	4500	350	400	3.7		4.3×10^{8}	8.6×10^{8}	8.2 × 10 ⁻¹¹	1.6×10^{-10}		
P16849-011CF	3270	3300	3330	160	180	2.8]	3.2×10^{8}	6.5×10^{8}	1.1×10^{-10}	2.2×10^{-10}		
P10049-011CF	3820	3900	3980	90	110	3.2]	3.7×10^{8}	7.4×10^{8}	9.5 × 10 ⁻¹¹	1.9×10^{-10}		
P16849-012CF	4217	4260	4303	140	160	3.2]	3.7 × 10 ⁸	7.4×10^{8}	9.5 × 10 ⁻¹¹	1.9×10^{-10}		
F10049-012CF	3820	3900	3980	90	110	3.2		3.7×10^{8}	7.4×10^{8}	9.5 × 10 ⁻¹¹	1.9×10^{-10}		

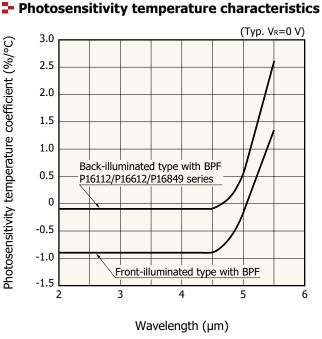
*4: VR=0 V, RL=50 Ω, 10 to 90%

*5: VR=0 V, f=1 MHz

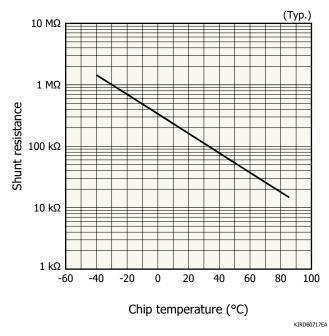


Spectral response





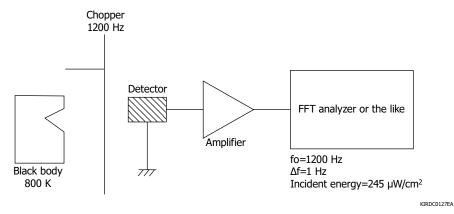
Shunt resistance vs. chip temperature



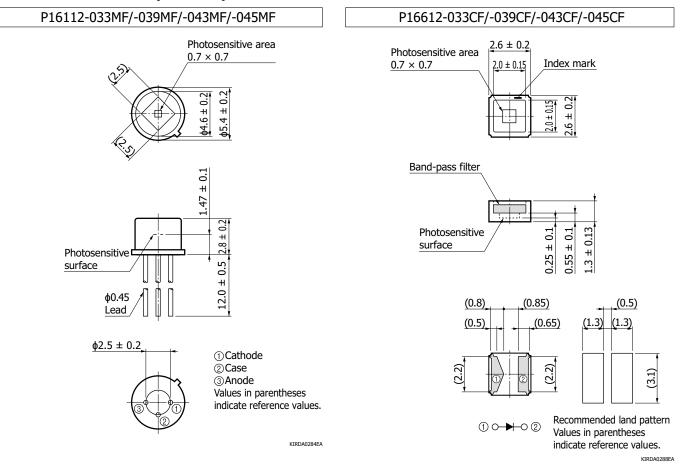


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Measurement circuit example

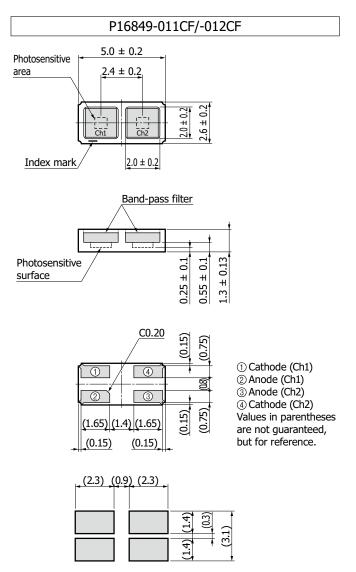


Dimensional outlines (unit: mm)





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Recommended land pattern

Type no.	Ch1	Ch2
P16849-011CF	3.3 µm	3.9 µm
P16849-012CF	4.26 µm	3.9 µm

KIRDA0287EA



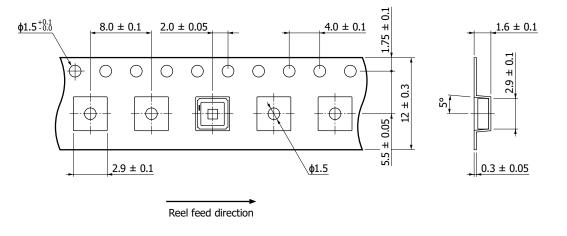
Standard packing specifications

P16612-033CF/-039CF/-043CF/-045CF

Reel (conforms to JEITA ET-7200)

Outer diameter	Hub diameter	Tape width	Material	Electrostatic characteristics
φ180 mm	φ60 mm	12 mm	PS	Conductive

Embossed tape (unit: mm, material: PS, conductive)





KLEDC0143EA

- Packing quantity 500 pcs/reel
- Packing state

Reel and desiccant in moisture-proof packaging (vacuum-sealed)

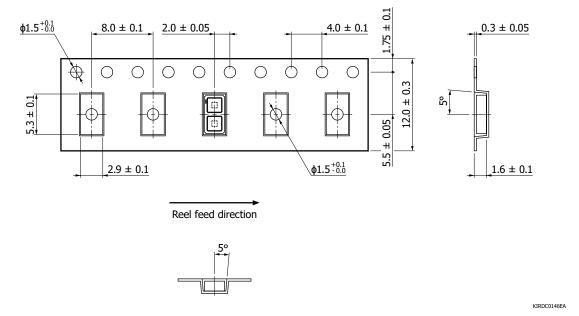


P16849-011CF/-012CF

Reel (confo	orms to JEITA	ET-7200)
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Outer diameter	Hub diameter	Tape width	Material	Electrostatic characteristics
φ180 mm	φ60 mm	12 mm	PS	Conductive

Embossed tape (unit: mm, material: PS, conductive)



- Packing quantity 100 pcs/reel
- Packing state

Reel and desiccant in moisture-proof packaging (vacuum-sealed)



Recommended soldering conditions

P16112-033MF/-039MF/-043MF/-045MF

· Solder temperature: 260 °C (10 s or less, once)

Solder the leads at a point at least 1 mm away from the package body.

Note: When you set soldering conditions, check that problems do not occur in the product by testing out the conditions in advance.

KSPDR0418FA

P16612-033CF/-039CF/-043CF/-045CF, P16849-011CF/-012CF Peak temperature Peak temperature - 5 °C 240 °C max. 30 s max. Temperature increase Cooling 3 °C/s max. 6 °C/s max. 217 °C 200 °C Temperature 150 °C Preheat Soldering 60 to 120 s 60 to 150 s 25 °C to peak temperature 8 m max.

• After unpacking, store the device in an environment at a temperature range of 5 to 30 °C and a humidity of 60% or less, and perform reflow soldering within 1 year.

• The effect that the product receives during reflow soldering varies depending on the circuit board and reflow oven that are used. When you set reflow soldering conditions, check that problems do not occur in the product by testing out the conditions in advance.

Time

HAMAMATSU

Related products

Evaluation kits M16607 series for InAsSb photovoltaic detector



The M16007 series are evaluation kits with an amplifier incorporating Hamamatsu's InAsSb photovoltaic detector (ceramic package with band-pass filter). These can detect infrared light transmitted through a band-pass filter simply by connecting a power supply (\pm 15 V). Two-element type that can detect two wavelengths is also available.

Specifications

- Gain: 30 V/V
- Frequency characteristics: DC to 80 kHz
- Recommended drive voltage: ±15 V
- Built-in sensor: InAsSb photovoltaic detector (ceramic package with band-pass filter)

Type no.	Built-in sensor	Center wavelength (µm)
M16607-033CF	P16612-033CF	3.3
M16607-039CF	P16612-039CF	3.9
M16607-043CF	P16612-043CF	4.26
M16607-015CF	P16849-011CF	3.3, 3.9
M16607-016CF	P16849-012CF	4.26, 3.9

Evaluation kit M16615 for mid infrared LED

The M16615 is a driver for mid infrared LED (TO-46 package). The LED can be pulsedriven simply by connecting a power supply (+15 V). This is used in combination with the evaluation kit M16607 series for InAsSb photovoltaic detector.

Specifications

- Applicable LED: Mid infrared LED (TO-46 package)
- Output current: 400 mA
- Output pulse: 10 µs
- Output cycle: 1000 µs
- Recommended drive voltage: +15 V



Note: LED sold separately



Related information

www.hamamatsu.com/sp/ssd/doc_en.html

- Precautions
- Disclaimer
- Safety consideration
- Surface mount type products
- · Compound opto-semiconductors (photosensors, light emitters)

Technical note

· Compound semiconductor photosensors

Information described in this material is current as of August 2023.

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